## HV2607/HV2707/HV2708

# No High-Voltage Bias, Low Harmonic Distortion, <br> 16-Channel, High-Voltage Analog Switch 

## Features

- 16-Channel High-Voltage Analog Switch
- Analog Signal Voltage Up to $\pm 100 \mathrm{~V}$
- Only +5V Bias Supply Required
- 3.3V and 5V CMOS Input Logic Level
- 66 MHz Data Shift Clock Frequency
- Ultra-Low Quiescent Current < $10 \mu \mathrm{~A}$
- Low Parasitic Capacitance
- Low Harmonic Distortion
- DC to 100 MHz Analog Small Signal Frequency
- 200 kHz to 50 MHz Large Signal Frequency
- -76 dB Typical Off Isolation at 5.0 MHz
- Excellent Noise Immunity
- Cascadable Serial Data Register with Latches
- Integrated Bleed Resistors on the Outputs (both sides for HV2707, one side for HV2708)


## Application

- Medical Ultrasound Imaging
- Non-Destructive Testing (NDT) Metal Flaw Detection
- Piezoelectric Transducer Drivers
- Inkjet Printer Head
- Optical MEMS Module


## General Description

HV2607/HV2707/HV2708 devices are low harmonic distortion, low charge injection, 16-channel, highvoltage analog switches without high-voltage supplies. They are intended for use in applications requiring high-voltage switching controlled by low-voltage control signals, such as medical ultrasound imaging, driving piezoelectric transducers and printers.

The HV2707 has integrated bleed resistors at both sides of the switches. The HV2708 has integrated bleed resistors at the SWA side only. The HV2607 has no bleed resistors. The bleed resistor eliminates voltage build up on capacitive loads, such as piezoelectric transducers.

The HV2607/HV2707/HV2708 devices require no high-voltage supplies and require only +5 V or +6 V bias supply. The analog input voltage range is up to $\pm 100 \mathrm{~V}$, even though there are no high-voltage supplies.
The HV2607/HV2707/HV2708 devices are offered in a 48-pin LQFP package, which is pin-to-pin compatible with HV2601/HV2701 and HV2605/HV2705 devices, except power supply pins.

## Package Types



## Block Diagram



### 1.0 ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings $\dagger$
Logic Supply Voltage ( $\mathrm{V}_{\mathrm{LL}}$ ) ..... -0.5 V to 6.6 V
Positive Supply Voltage ( $\mathrm{V}_{\mathrm{DD}}$ ). ..... -0.5 V to 6.6 V
Logic Input Voltage ( $\mathrm{V}_{\mathrm{IN}}$ ) ..... -0.5 V to $\mathrm{V}_{\mathrm{LL}}+0.3 \mathrm{~V}$
Analog Signal Range ( $\mathrm{V}_{\text {SIG }}$ ) ..... -110 V to +110 V
Peak Analog Signal Current/Channel (IPK) ..... 1.9A ..... 1.9A
$\dagger$ Notice: Stresses above those listed under "Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operational sections of this specification is not intended. Exposure to maximum rating conditions for extended periods may affect device reliability.

## RECOMMENDED OPERATING CONDITIONS ${ }^{(1,2,3)}$

| Parameter | Sym. | Min. | Typ. | Max. | Units | Conditions |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: |
| Logic Supply Voltage | $\mathrm{V}_{\mathrm{LL}}$ | 3 | - | 5.5 | V |  |
| Positive Supply Voltage | $\mathrm{V}_{\mathrm{DD}}$ | 4.5 | - | 6.3 | V |  |
| High-Level Input Voltage | $\mathrm{V}_{\mathrm{IH}}$ | $0.9 \mathrm{~V}_{\mathrm{LL}}$ | - | $\mathrm{V}_{\mathrm{LL}}$ | V |  |
| Low-Level Input Voltage | $\mathrm{V}_{\mathrm{IL}}$ | 0 | - | $0.1 \mathrm{~V}_{\mathrm{LL}}$ | V |  |
| Analog Signal Voltage Peak-to-Peak | $\mathrm{V}_{\mathrm{SIG}}$ | -100 | - | 100 | V |  |

Note 1: Power-up sequence is $V_{L L}$ first and then $V_{D D}$. Power-down sequence is the reverse of power-up.
2: $\quad \mathrm{V}_{\text {SIG }}$ must be $G N D \leq \mathrm{V}_{\mathrm{SIG}} \leq \mathrm{V}_{\mathrm{DD}}$ or floating during power-up/down transition.
3: Rise and fall times of power supplies, $\mathrm{V}_{\mathrm{LL}}$ and $\mathrm{V}_{\mathrm{DD}}$, should be greater than 1.0 ms .

## HV2607/HV2707/HV2708

## DC ELECTRICAL CHARACTERISTICS

Unless otherwise specified, $\mathrm{V}_{\mathrm{LL}}=+5 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}=+5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$.
Boldface specifications apply over the full operating temperature range.

| Parameter | Sym. | Min. | Typ. | Max. | Units | Conditions/Comments |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Small Signal Switch On-Resistance | $\mathrm{R}_{\text {ONS }}$ | - | 14 | 23 | $\Omega$ | $\mathrm{I}_{\text {SIG }}=5 \mathrm{~mA}$ |
|  |  | - | 14.5 | 23 | $\Omega$ | $\mathrm{I}_{\text {SIG }}=200 \mathrm{~mA}$ |
| Small Signal Switch On-Resistance Matching | $\Delta \mathrm{R}_{\text {ONS }}$ | - | 5 | 20 | \% | $\mathrm{I}_{\text {SIG }}=5 \mathrm{~mA}$ |
| Large Signal Switch On-Resistance | $\mathrm{R}_{\mathrm{ONL}}$ | - | 12 | - | $\Omega$ | $\mathrm{V}_{\text {SIG }}=90 \mathrm{~V}, \mathrm{R}_{\text {LOAD }}=70 \Omega$ (Note 1) |
| Value of Output Bleed Resistor (HV2707/HV2708 only) | $\mathrm{R}_{\text {INT }}$ | 20 | 35 | 50 | k $\Omega$ | $\mathrm{I}_{\text {RINT }}=0.1 \mathrm{~mA}$ |
| Switch Off Leakage per Switch | $\mathrm{I}_{\text {SOL }}$ | - | - | 10 | $\mu \mathrm{A}$ | $\mathrm{V}_{\mathrm{SIG}}=+100 \mathrm{~V}, 500 \mu \mathrm{~s}$ pulse, see Figure 3-1 |
|  |  | - | - | 10 | $\mu \mathrm{A}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{SIG}}=-100 \mathrm{~V}, 100 \mu \mathrm{~s} \text { pulse, } \\ & \text { see Figure 3-1 (Note 1) } \end{aligned}$ |
| HV2607 |  |  |  |  |  |  |
| Switch Off Bias per Switch | $I_{\text {SOB }}$ | - | - | 3 | $\mu \mathrm{A}$ | $\mathrm{V}_{\mathrm{SIG}}=+100 \mathrm{~V}, 500 \mu \mathrm{~s}$ pulse, see Figure 3-2 |
|  |  | - | - | 100 | $\mu \mathrm{A}$ | $\mathrm{V}_{\text {SIG }}=-100 \mathrm{~V}, 100 \mu \mathrm{~s}$ pulse, see Figure 3-2 (Note 1) |
| HV2707 |  |  |  |  |  |  |
| Switch Off Bias of All SWA and SWB Switches | $\mathrm{I}_{\text {SOB }}$ | - | - | 3 | $\mu \mathrm{A}$ | $\mathrm{V}_{\text {SIG }}=+100 \mathrm{~V}, 500 \mu \mathrm{~s}$ pulse, see Figure 3-2 |
|  |  | - | - | 3 | mA | $\mathrm{V}_{\text {SIG }}=-100 \mathrm{~V}, 100 \mu \mathrm{~s}$ pulse, see Figure 3-2 (Note 1) |
| HV2708 |  |  |  |  |  |  |
| Switch Off Bias of All SWA (with Bleed Resistor) Switches | $\mathrm{I}_{\text {SOB }}$ | - | - | 3 | $\mu \mathrm{A}$ | $\mathrm{V}_{\mathrm{SIG}}=+100 \mathrm{~V}, 500 \mu \mathrm{~s}$ pulse, see Figure 3-2 |
|  |  | - | - | 1.5 | mA | $V_{\text {SIG }}=-100 \mathrm{~V}, 100 \mu$ s pulse, see Figure 3-2 (Note 1) |
| Switch Off Bias per SWB (without Bleed Resistor) Switch |  | - | - | 3 | $\mu \mathrm{A}$ | $\mathrm{V}_{\text {SIG }}=+100 \mathrm{~V}, 500 \mu \mathrm{~s}$ pulse, see Figure 3-2 |
|  |  | - | - | 100 | $\mu \mathrm{A}$ | $\mathrm{V}_{\text {SIG }}=-100 \mathrm{~V}, 100 \mu$ s pulse, see Figure 3-2 (Note 1) |
| Switch Off DC Offset | $\mathrm{V}_{\mathrm{OS}}$ | - | 1 | 10 | mV | $R_{\text {LOAD }}=25 \mathrm{k} \Omega(\mathrm{HV} 2607) / 50 \mathrm{k} \Omega(\mathrm{HV} 2708),$ no load (HV2707), see Figure 3-3 (Note 1) |
| Switch On DC Offset |  | - | 1 | 10 |  |  |
| Quiescent $\mathrm{V}_{\mathrm{DD}}$ Supply Current | $\mathrm{I}_{\text {DDQ }}$ | - | - | 10 | $\mu \mathrm{A}$ | All switches off |
|  |  | - | - | 10 |  | All switches on, $\mathrm{V}_{\text {SW }}=1 \mathrm{~V}$ |
| Quiescent $\mathrm{V}_{\text {LL }}$ Supply Current | ILLQ | - | 1 | 10 | $\mu \mathrm{A}$ | All logic inputs are GND |
| Switch Output Peak Current | $\mathrm{I}_{\text {SW }}$ | 1.3 | 1.9 | - | A | $\mathrm{V}_{\text {SIG }}$ duty cycle < $0.1 \%$ (Note 1) |
| Output Switching Frequency | $\mathrm{f}_{\text {SW }}$ | - | - | 50 | kHz | Duty cycle $=50 \%$ (Note 1) |
| Average $\mathrm{V}_{\text {DD }}$ Supply Current | $\mathrm{I}_{\mathrm{DD}}$ | - | 3.7 | 6 | mA | All output switches are turning on and off at 50 kHz with no load |
| Average $\mathrm{V}_{\text {LL }}$ Supply Current | $\mathrm{I}_{\text {LL }}$ | - | 0.3 | 0.5 | mA | $\mathrm{f}_{\mathrm{CLK}}=5.0 \mathrm{MHz}, \mathrm{f}_{\text {DIN }}=2.5 \mathrm{MHz}$ |
| Data Out Source Current | $\mathrm{I}_{\text {SOR }}$ | 10 | - | - | mA | $\mathrm{V}_{\text {OUT }}=\mathrm{V}_{\mathrm{LL}}-0.7 \mathrm{~V}$ |
| Data Out Sink Current | $\mathrm{I}_{\text {SINK }}$ | 10 | - | - | mA | $\mathrm{V}_{\text {OUT }}=0.7 \mathrm{~V}$ |
| Logic Input Capacitance | $\mathrm{C}_{\mathrm{IN}}$ | - | 8 | - | pF | Note 2 |

Note 1: Specification is obtained by characterization and is not $100 \%$ tested.
2: Design guidance only.

## AC ELECTRICAL CHARACTERISTICS

Unless otherwise specified, $\mathrm{V}_{\mathrm{LL}}=+5 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}=+5 \mathrm{~V}, \mathrm{t}_{\mathrm{R}}=\mathrm{t}_{\mathrm{F}} \leq 5.0 \mathrm{~ns}, 50 \%$ duty cycle, $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$.
Boldface specifications apply over the full operating temperature range.

| Parameter | Sym. | Min. | Typ. | Max. | Units | Conditions/Comments |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Setup Time Before $\overline{\mathrm{LE}}$ Rises | $t_{\text {SD }}$ | 25 | - | - | ns | Note 1 |
| Time Width of $\overline{\text { LE }}$ | $t_{\text {WLE }}$ | 12 | - | - | ns | Note 1 |
| Clock Delay Time to Data Out | $\mathrm{t}_{\mathrm{DO}}$ | - | - | 13.5 | ns |  |
| Time Width of CLR | $\mathrm{t}_{\text {WCLR }}$ | 55 | - | - | ns | Note 1 |
| Setup Time Data to Clock | $t_{\text {SU }}$ | 1.5 | - | - | ns | Note 1 |
| Hold Time Data from Clock | $\mathrm{t}_{\mathrm{H}}$ | 1.5 | - | - | ns | Note 1 |
| Clock Frequency | $\mathrm{f}_{\text {CLK }}$ | - | - | 66 | MHz | $50 \%$ duty cycle, $\mathrm{f}_{\mathrm{DIN}}=(1 / 2) \mathrm{f}_{\mathrm{CLK}}$, $\mathrm{C}_{\text {DOUT }}=20 \mathrm{pF}$ (Note 1) |
| Clock Rise and Fall Times | $t_{R}, t_{F}$ | - | - | 50 | ns |  |
| Turn-On Time | $\mathrm{t}_{\mathrm{ON}}$ | - | - | 5 | $\mu \mathrm{s}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{SIG}}=5 \mathrm{~V}, \mathrm{R}_{\mathrm{LOAD}}=550 \Omega, \\ & \text { see Figure 3-4 } \end{aligned}$ |
| Turn-Off Time | $\mathrm{t}_{\text {OFF }}$ | - | - | 5 | $\mu \mathrm{s}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{SIG}}=5 \mathrm{~V}, \mathrm{R}_{\mathrm{LOAD}}=550 \Omega, \\ & \text { see Figure 3-4 } \end{aligned}$ |
| Input Large Signal Pulse Width | $t_{\text {PW }}$ | - | - | 2.5 | $\mu \mathrm{s}$ | $\mathrm{V}_{\text {PULSE }}=0 \mathrm{~V}$ to $\pm 100 \mathrm{~V}$, measured at 90\% amplitude, see Figure 3-5 <br> (Note 1) |
| Maximum $\mathrm{V}_{\text {SIG }}$ Slew Rate | $\mathrm{dV} / \mathrm{dt}$ | - | - | 20 | V/ns | Note 1 |
| Analog Small Signal Frequency | $\mathrm{f}_{\text {BWS }}$ | - | 100 | - | MHz | Note 1 |
| Off Isolation | $\mathrm{K}_{\mathrm{O}}$ | - | -64 | -60 | dB | $\mathrm{f}=5.0 \mathrm{MHz}, 1.0 \mathrm{k} \Omega / / 15 \mathrm{pF} \text { load, }$ see Figure 3-6 (Note 1) |
|  |  | - | -76 | -70 | dB | $\begin{aligned} & \mathrm{f}=5.0 \mathrm{MHz}, 50 \Omega \text { load, } \\ & \text { see Figure 3-6 (Note } 1 \text { ) } \end{aligned}$ |
| Switch Crosstalk | $\mathrm{K}_{\mathrm{CR}}$ | - | -70 | -60 | dB | $\begin{aligned} & \mathrm{f}=5.0 \mathrm{MHz}, 50 \Omega \text { load, } \\ & \text { see Figure 3-7 (Note } 1 \text { ) } \end{aligned}$ |
| Off Capacitance SW to GND | $\mathrm{C}_{\text {SG(OFF) }}$ | - | 9 | - | pF | $\mathrm{V}_{\text {SIG }}=50 \mathrm{mV}$ @1 MHz, no load (Note 1) |
| On Capacitance SW to GND | $\mathrm{C}_{\text {SG(ON) }}$ | - | 17 | - | pF | $\mathrm{V}_{\text {SIG }}=50 \mathrm{mV}$ @ 1 MHz , no load (Note 1) |
| Output Voltage Spike at SWA, SWB | $+\mathrm{V}_{\text {SPK }}$ | - | - | 40 | mV | $R_{\text {LOAD }}=50 \Omega$, see Figure 3-8 (Note 1) |
|  | $-V_{\text {SPK }}$ | -10 | - | - | mV |  |
| Charge Injection | QC | - | 110 | - | pC | See Figure 3-8 (Note 1) |
| Second Harmonic Distortion | HD2 | - | -64 | - | dBc | $\mathrm{V}_{\text {SIG }}=1.5 \mathrm{~V} @ 5 \mathrm{MHz}, 50 \Omega$ load (Note 1) |
|  |  | - | -60 | - | dBc | $\begin{aligned} & \mathrm{V}_{\mathrm{SIG}}=1.5 \mathrm{~V} @ 5 \mathrm{MHz}, \\ & 1 \mathrm{k} \Omega / / 15 \mathrm{pF} \text { load (Note 1) } \end{aligned}$ |

Note 1: Specification is obtained by characterization and is not $100 \%$ tested.

## HV2607/HV2707/HV2708

## TEMPERATURE SPECIFICATION

| Parameters | Sym | Min | Typ | Max | Units | Conditions |  |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Temperature Range |  |  |  |  |  |  |  |
| Operating Temperature | $\mathrm{T}_{\mathrm{A}}$ | 0 | - | +70 | ${ }^{\circ} \mathrm{C}$ |  |  |
| Storage Temperature | $\mathrm{T}_{\mathrm{S}}$ | -65 | - | +150 | ${ }^{\circ} \mathrm{C}$ |  |  |
| Maximum Junction Temperature | $\mathrm{T}_{\mathrm{J}}$ | - | - | +125 | ${ }^{\circ} \mathrm{C}$ |  |  |
| Package Thermal Resistance |  |  |  |  |  |  |  |
| Thermal Resistance, LQFP | $\Theta_{\mathrm{JA}}$ | - | 52 | - | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |  |  |

TABLE 1-1: $\quad$ TRUTH TABLE ${ }^{(1,2,3,4,5,6)}$

| DO | D1 | ... | D7 | D8 | ... | D15 | LE | CLR | SW0 | SW1 | ... | SW7 | SW8 | ... | SW15 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| L | - | $\ldots$ | - | - | ... | - | L | L | OFF | - | $\ldots$ | - | - | $\ldots$ | - |
| H | - |  | - | - |  | - | L | L | ON | - |  | - | - |  | - |
| - | L |  | - | - |  | - | L | L | - | OFF |  | - | - |  | - |
| - | H |  | - | - |  | - | L | L | - | ON |  | - | - |  | - |
| - | - |  | - | - |  | - | L | L | - | - |  | - | - |  | - |
| - | - |  | - | - |  | - | L | L | - | - |  | - | - |  | - |
| - | - |  | L | - |  | - | L | L | - | - |  | OFF | - |  | - |
| - | - |  | H | - |  | - | L | L | - | - |  | ON | - |  | - |
| - | - |  | - | L |  | - | L | L | - | - |  | - | OFF |  | - |
| - | - |  | - | H |  | - | L | L | - | - |  | - | ON |  | - |
| - | - |  | - | - |  | - | L | L | - | - |  | - | - |  | - |
| - | - |  | - | - |  | - | L | L | - | - |  | - | - |  | - |
| - | - |  | - | - |  | L | L | L | - | - |  | - | - |  | OFF |
| - | - |  | - | - |  | H | L | L | - | - |  | - | - |  | ON |
| X | X | X | X | X | X | X | H | L |  |  | D | EVIO | S STA |  |  |
| X | X | X | X | X | X | X | X | H |  |  | L | ITCH | S OFF |  |  |

Note 1: The 16 switches operate independently.
2: Serial data are clocked in on the $L$ to $H$ transition of the CLK.
3: All 16 switches go to a state retaining their latched condition at the rising edge of $\overline{\mathrm{LE}}$. When $\overline{\mathrm{LE}}$ is low, the shift registers' data flow through the latch.
4: $\quad D_{\text {OUT }}$ is high when the data in Register 15 are high.
5: Shift register clocking has no effect on the switch states if $\overline{\mathrm{LE}}$ is high.
6: The CLR (clear) input overrides all of the inputs.

### 1.1 Typical Timing Diagram

Figure 1-1 shows the timing of AC characteristic parameters graphically.


FIGURE 1-1: Logic Input Timing Diagram.

### 2.0 PIN DESCRIPTION

This section details the pin description for the 48-Lead LQFP package (Figure 2-1). The descriptions of the pins are listed in Table 2-1.


FIGURE 2-1:
48-Lead LQFP Package - Top View.

TABLE 2-1: PIN FUNCTION TABLE

| Pin Number | Symbol |  | Description |
| :---: | :---: | :---: | :---: |
|  | HV2607 | HV2707/HV2708 |  |
| 1 | NC | NC | No Connection |
| 2 | NC | NC | No Connection |
| 3 | SW4B | SW4B | Analog Switch 4 Terminal B |
| 4 | SW4A | SW4A | Analog Switch 4 Terminal A |
| 5 | SW3B | SW3B | Analog Switch 3 Terminal B |
| 6 | SW3A | SW3A | Analog Switch 3 Terminal A |
| 7 | SW2B | SW2B | Analog Switch 2 terminal B |
| 8 | SW2A | SW2A | Analog Switch 2 Terminal A |
| 9 | SW1B | SW1B | Analog Switch 1 Terminal B |
| 10 | SW1A | SW1A | Analog Switch 1 Terminal A |
| 11 | SWOB | SWOB | Analog Switch 0 Terminal B |
| 12 | SWOA | SWOA | Analog Switch 0 Terminal A |
| 13 | GND | GND | Ground |
| 14 | NC | NC | No Connection |
| 15 | $\mathrm{V}_{\mathrm{DD}}$ | $\mathrm{V}_{\mathrm{DD}}$ | Positive Supply Voltage |
| 16 | NC | NC | No Connection |
| 17 | DGND | DGND | Digital Ground |
| 18 | $\mathrm{V}_{\text {LL }}$ | $\mathrm{V}_{\text {LL }}$ | Logic Supply Voltage |
| 19 | DIN | $\mathrm{D}_{\text {IN }}$ | Data In Logic Input |
| 20 | CLK | CLK | Clock Logic Input for Shift Register |
| 21 | $\overline{\text { LE }}$ | $\overline{\text { LE }}$ | Latch Enable Logic Input, Low Active |
| 22 | CLR | CLR | Latch Clear Logic Input |
| 23 | DOUT | DOUT | Data Out Logic Output |
| 24 | NC | RGND | No Connection/Ground for Bleed Resistor |
| 25 | SW15B | SW15B | Analog Switch 15 Terminal B |
| 26 | SW15A | SW15A | Analog Switch 15 Terminal A |
| 27 | SW14B | SW14B | Analog Switch 14 Terminal B |
| 28 | SW14A | SW14A | Analog Switch 14 Terminal A |
| 29 | SW13B | SW13B | Analog Switch 13 Terminal B |
| 30 | SW13A | SW13A | Analog Switch 13 Terminal A |
| 31 | SW12B | SW12B | Analog Switch 12 Terminal B |
| 32 | SW12A | SW12A | Analog Switch 12 Terminal A |
| 33 | SW11B | SW11B | Analog Switch 11 Terminal B |
| 34 | SW11A | SW11A | Analog Switch 11 Terminal A |
| 35 | NC | NC | No Connection |
| 36 | NC | NC | No Connection |
| 37 | SW10B | SW10B | Analog Switch 10 Terminal B |
| 38 | SW10A | SW10A | Analog Switch 10 Terminal A |
| 39 | SW9B | SW9B | Analog Switch 9 Terminal B |
| 40 | SW9A | SW9A | Analog Switch 9 Terminal A |
| 41 | SW8B | SW8B | Analog Switch 8 Terminal B |
| 42 | SW8A | SW8A | Analog Switch 8 Terminal A |
| 43 | SW7B | SW7B | Analog Switch 7 Terminal B |
| 44 | SW7A | SW7A | Analog Switch 7 Terminal A |
| 45 | SW6B | SW6B | Analog Switch 6 Terminal B |
| 46 | SW6A | SW6A | Analog Switch 6 Terminal A |
| 47 | SW5B | SW5B | Analog Switch 5 Terminal B |
| 48 | SW5A | SW5A | Analog Switch 5 Terminal A |

## HV2607/HV2707/HV2708

### 3.0 TEST CIRCUIT EXAMPLES

This section details a few examples of test circuits.


FIGURE 3-1:
Switch Off Leakage per
Switch.


FIGURE 3-2: $\quad$ Switch Off Bias per Switch.


FIGURE 3-3:
Switch DC Offset.


FIGURE 3-4: $\quad T_{\text {ON }} / T_{\text {OFF }}$ Test Circuit.


FIGURE 3-5: Tx Pulse Width.


FIGURE 3-6: Off Isolation.


FIGURE 3-7:
Switch Crosstalk.


FIGURE 3-8:
Output Voltage Spike.


## HV2607/HV2707/HV2708

### 4.0 TYPICAL PERFORMANCE CURVES

Note: The graphs and tables provided following this note are a statistical summary based on a limited number of samples and are provided for informational purposes only. The performance characteristics listed herein are not tested or guaranteed. In some graphs or tables, the data presented may be outside the specified operating range (e.g., outside specified power supply range) and therefore outside the warranted range.

Note: Unless otherwise specified, $\mathrm{V}_{\mathrm{LL}}=+5 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}=+5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$.

##  <br> FIGURE 4-1: $\quad R_{\text {ONS }}$ at 5 mA vs $V_{D D}$.



FIGURE 4-2:
$I_{D D}$ Vs. Switching
Frequency.


FIGURE 4-3: $\quad I_{D D Q} I_{L L Q}$ vs. Temperature.


FIGURE 4-4: $\quad T_{\text {ON }} / T_{\text {OFF }}$ vs. Temperature.


FIGURE 4-5: I IL vs. CLK Frequency.


FIGURE 4-6: $\quad K_{O}$ vs. Frequency with $50 \Omega$ Load.

### 5.0 DETAILED DESCRIPTION AND APPLICATION INFORMATION

### 5.1 Device Overview

The HV2607/HV2707/HV2708 devices are low harmonic distortion, low charge injection, 16-channel, highvoltage analog switches without high-voltage supplies. The high-voltage analog switches are used for multiplexing a piezoelectric transducer array in a probe to multiple channel transmitter (Tx) arrays in a medical ultrasound system.

The HV2607/HV2707/HV2708 devices are distinguished by bleed resistors that eliminate voltage build-up in capacitance load, such as piezoelectric transducers. These devices can pass $\pm 100 \mathrm{~V}$ high-voltage pulses without high-voltage bias, such as $\pm 100 \mathrm{~V}$. These devices have typical $14 \Omega$ on-resistance and 100 MHz bandwidth for small signals.
Figure 5-1 shows a typical medical ultrasound image system consisting of 64 channels of transmit pulsers, 64 channels of receivers (LNA and ADC) and 64 channels of T/R switches connecting to 192 elements of an ultrasound probe via a HV2XXX high-voltage analog switch array.


FIGURE 5-1:
Typical Medical Ultrasound Imaging System.

### 5.2 Logic Input Timing

The HV2607/HV2707/HV2708 devices have a digital serial interface consisting of Data In ( $\mathrm{D}_{\text {IN }}$ ), Clock (CLK), Data Out ( $\mathrm{D}_{\mathrm{OUT}}$ ), Latch Enable ( $\overline{\mathrm{LE}}$ ) and Clear (CLR) to control 16 switches individually. The digital circuits are supplied by $\mathrm{V}_{\mathrm{LL}}$ and connected to DGND. The serial clock frequency is up to 66 MHz .
The switch state configuration data are shifted into the shift registers on the rising edge (low-to-high transition) of the clock. The switch Configuration bit of SW15 is shifted in first and the Configuration bit of SWO is shifted in last. To change all the switch states at the same time, the Latch Enable ( $\overline{\mathrm{LE}}$ ) input should remain high while the 16 -bit Data In signal is shifted into the 16-bit register. After the valid 16-bit data com-
plete shifting into the shift registers, the high-to-low transition of the $\overline{\mathrm{LE}}$ signal transfers the contents of the shift registers into the latches. Finally, setting the $\overline{\mathrm{LE}}$ high again allows all the latches to keep the current state, while new data can now be shifted into the shift registers without disturbing the latches.
It is recommended to change all the latch states at the same time through this method to avoid possible clock feed through noise (see Figure 5-2 for details).
When the CLR input is set high, it resets the data of all 16 latches to low. Consequently, all the high-voltage switches are set to the OFF state. However, the CLR signal does not affect the contents of the shift register, so the shift register can operate independently of the CLR signal. Therefore, when the CLR input is low, the shift register still retains the previous data.


FIGURE 5-2: Latch Enable Timing Diagram.

### 5.3 Multiple Devices Connection

The serial input interface of the HV2607/HV2707/HV2708 allows multiple devices to daisy-chain together. In this configuration, the $\mathrm{D}_{\text {OUT }}$ of a device is connected to the $D_{\text {IN }}$ of the subsequent device, and so forth. The last $D_{\text {OUT }}$ of the daisy-chained HV2607/HV2707/HV2708 can either be floating or fed back to an FPGA to check the previously stored shift register data.
To control all the high-voltage analog switch states in daisy-chained N devices, N -times 16 clocks and N times 16 bits of data are shifted into shift registers, while $\overline{\mathrm{LE}}$ remains high and CLR remains low. After all the data finish shifting in, one single negative pulse of $\overline{\mathrm{LE}}$ transfers the data from all shift registers to all the latches simultaneously. Consequently, all N-times 16 high-voltage analog switches change states simultaneously.

### 5.4 Power-up/Down Sequence and Decoupling Capacitor

The recommended power-up sequence of the HV2607/HV2707/HV2708 is $\mathrm{V}_{\mathrm{LL}}$ first, then $\mathrm{V}_{\mathrm{DD}}$. The power-down sequence is in reverse order of power-up. During the power-up/down period, all the analog switch inputs should be within $\mathrm{V}_{\mathrm{DD}}$ and GND or floating.

### 5.5 Layout Considerations

The HV2607/HV2707/HV2708 devices have two separate ground connections. DGND is the ground connection for digital circuitry and GND is the ground connection for substrate and analog switches. Since the analog switch passes large transient current from the pulser, the GND should be shared with the pulser output stage ground. It is important to have a good PCB layout which minimizes noise and ground bounce. It is recommended to use two separate ground planes in the PCB, connected together at the return terminal of the input power line, as shown in Figure 5-3. It is recommended that $0.1 \mu \mathrm{~F}$ or larger ceramic decoupling capacitors with low-ESR (Equivalent Series Resistance) and appropriate voltage ratings be connected between ground and power supplies, as shown in Figure 5-3. The decoupling capacitor of $\mathrm{V}_{\mathrm{LL}}$ and $\mathrm{V}_{\mathrm{DD}}$ should be connected to DGND. These decoupling capacitors should be placed as close as possible to the device.


FIGURE 5-3: Layout Guidelines.

### 6.0 PACKAGING INFORMATION

### 6.1 Package Marking Information



Example


Legend: $X X$...X Product Code or Customer-specific information
$Y \quad$ Year code (last digit of calendar year)
YY Year code (last 2 digits of calendar year)
WW Week code (week of January 1 is week ' 01 ')
NNN Alphanumeric traceability code
can be found on the outer packaging for this package.
Note: In the event the full Microchip part number cannot be marked on one line, it will be carried over to the next line, thus limiting the number of available characters for customer-specific information. Package may or may not include the corporate logo.

## 48-Lead Low-profile Plastic Quad Flat Pack Package (R8) -7x7 mm Body [LQFP] Supertex Legacy Package

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging


TOP VIEW


SIDE VIEW

## 48-Lead Low-profile Plastic Quad Flat Pack Package (R8) -7x7 mm Body [LQFP] Supertex Legacy Package

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging


SECTION A-A

## Notes:

| Units |  | MILLIMETERS |  |  |
| :---: | :---: | :---: | :---: | :---: |
|  |  | MIN | NOM | MAX |
| Number of Leads | N | 48 |  |  |
| Lead Pitch | e | 0.50 BSC |  |  |
| Overall Height | A | 1.40 | 1.50 | 1.60 |
| Standoff | A1 | 0.05 | 0.10 | 0.15 |
| Molded Package Thickness | A2 | 1.35 | 1.40 | 1.45 |
| Foot Length | L | 0.45 | 0.60 | 0.75 |
| Footprint | L1 | 1.00 REF |  |  |
| Foot Angle | $\theta$ | $0^{\circ}$ | $3.5{ }^{\circ}$ | $7^{\circ}$ |
| Overall Width | E | 9.00 BSC |  |  |
| Overall Length | D | 9.00 BSC |  |  |
| Molded Package Width | E1 | 7.00 BSC |  |  |
| Molded Package Length | D1 | 7.00 BSC |  |  |
| Lead Width | b | 0.17 | 0.22 | 0.27 |
| Mold Draft Angle Top | $\alpha$ | $11^{\circ}$ | $12^{\circ}$ | $13^{\circ}$ |

1. Pin 1 visual index feature may vary, but must be located within the hatched area.
2. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.
REF: Reference Dimension, usually without tolerance, for information purposes only.

## 48-Lead Low-profile Plastic Quad Flat Pack Package (R8) -7x7 mm Body [LQFP] Supertex Legacy Package

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging


RECOMMENDED LAND PATTERN

|  | Units | MILLIMETERS |  |  |
| :--- | :---: | :---: | :---: | :---: |
| Dimension Limits |  | MIN | NOM | MAX |
| Contact Pitch | E | 0.50 BSC |  |  |
| Contact Pad Spacing | C1 |  | 8.40 |  |
| Contact Pad Spacing | C2 |  | 8.40 |  |
| Contact Pad Width (X48) | X1 |  |  | 0.30 |
| Contact Pad Length (X48) | Y1 |  |  | 1.50 |
| Contact Pad to Contact Pad (X44) | G | 0.20 |  |  |

Notes:

1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.
2. For best soldering results, thermal vias, if used, should be filled or tented to avoid solder loss during reflow process

HV2607/HV2707/HV2708

NOTES:

## APPENDIX A: REVISION HISTORY

Revision A (July 2020)

- Original Release of this Document.

HV2607/HV2707/HV2708

NOTES:

## PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, refer to the factory or the listed sales office.

| PART NO. <br> Device | Reel |  | Examples: <br> a) HV2607T-C/R8X: No High-Voltage Bias, 16-Channel High-Voltage Analog Switch, 48-Lead LQFP package. |  |
| :---: | :---: | :---: | :---: | :---: |
| Device: | HV2607: <br> HV2707: <br> HV2708: | No High-Voltage Bias, 16-Channel High-Voltage Analog Switch (Tape and Reel) <br> No High-Voltage Bias, 16-Channel High-Voltage Analog Switch with Bleed Resistor at Both Sides of Switch (Tape and Reel) <br> No High-Voltage Bias, 16-Channel High-Voltage Analog Switch with Bleed Resistor at One Side of Switch (Tape and Reel) |  |  |
| Environmental: Package: | $C=$ $R 8 X=$ | Lead (Pb)-Free/ROHS-Compliant Package <br> Low Profile Plastic Quad Flat Pack Package, $7 \times 7$ mm Body, 48-Lead (LQFP) | Note 1: | 1: Tape and Reel identifier only appears in the catalog part number description. This identifier is used for ordering purposes and is not printed on the device package. Check with your Microchip Sales Office for package availability with the Tape and Reel option. |

HV2607/HV2707/HV2708

NOTES:

## Note the following details of the code protection feature on Microchip devices:

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